

Hutchip
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HC2333

12V P-Channel MOSFET

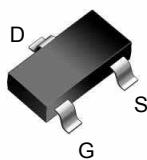
General Description

These P-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

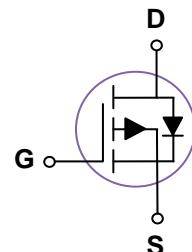
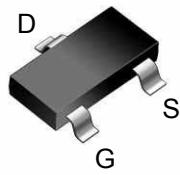
Features

V_{DS}	-12V
I_D (at $V_{GS}=-4.5V$)	-6.0A
$R_{DS(ON)}$ (at $V_{GS}=-4.5V$)	22mΩ(Typ)

SOT23



SOT23-3



Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	V_{DS}	-12	V
Gate-Source Voltage	V_{GS}	± 10	V
Drain Current-Continuous	I_D (TC=25°C)	-6.0	A
	I_D (TC=100°C)	-3.8	A
Maximum Power Dissipation	P_D	1.56	W
Drain Current – Pulsed1	I_{DM}	-24	A
Junction and Storage Temperature Range	T_J, T_{STG}	-55 To 150	°C
Thermal Characteristics			
Parameter	Symbol	Typ	Max
Thermal Resistance junction-case	$R_{\theta JC}$		60
Thermal Resistance junction-to-Ambient	$R_{\theta JA}$		80

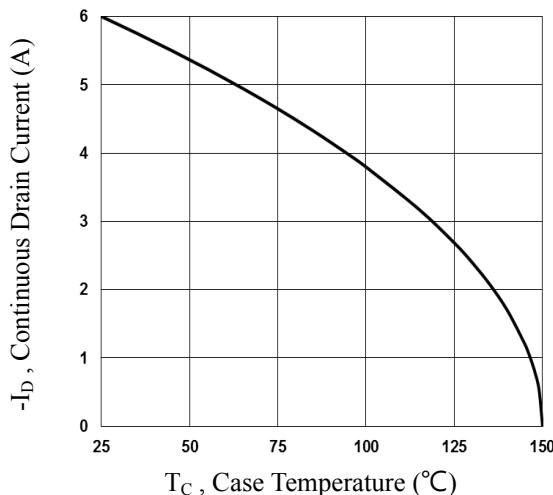
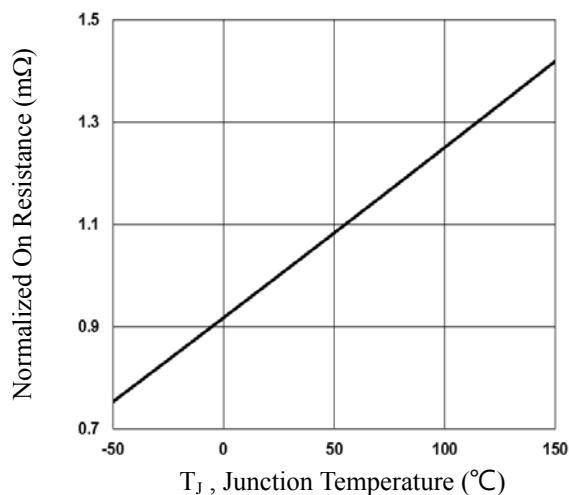
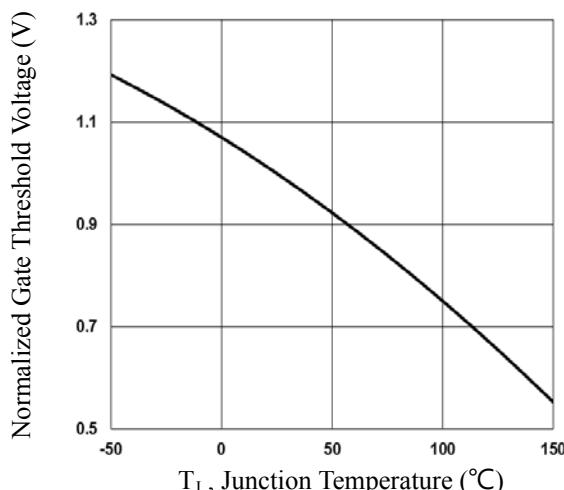
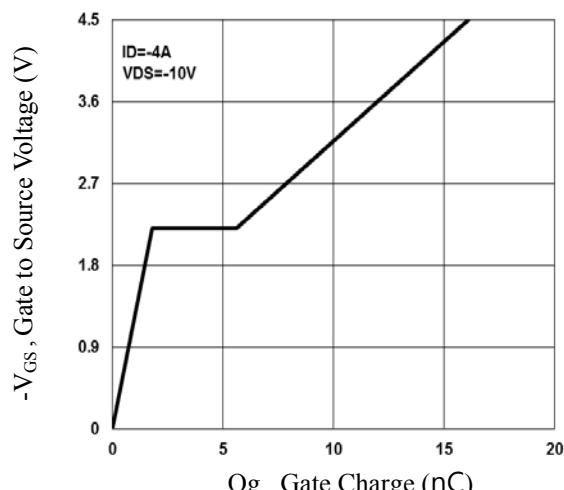
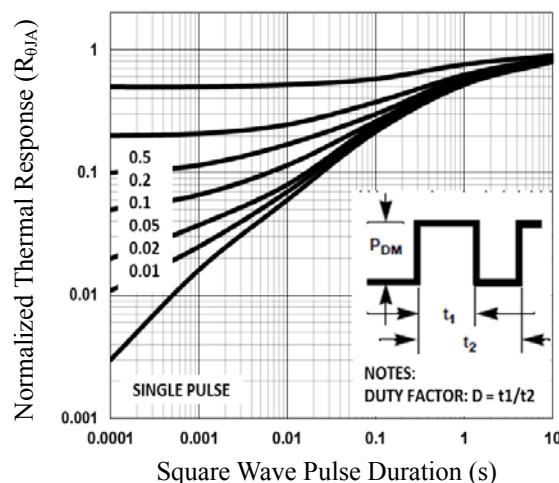
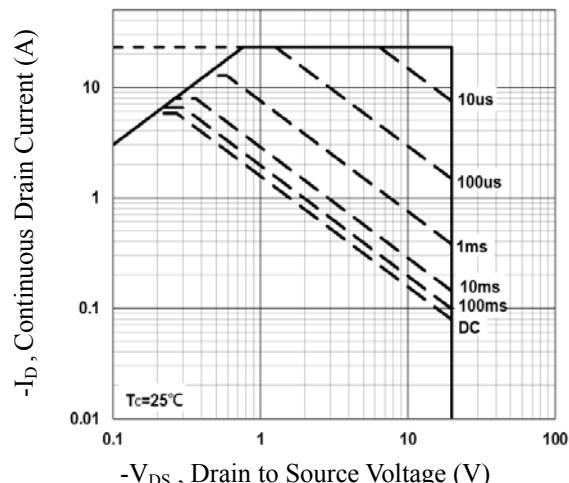
Electrical Characteristics (TJ=25°C unless otherwise noted)

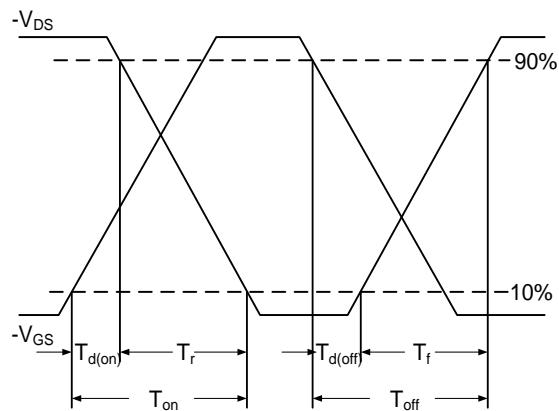
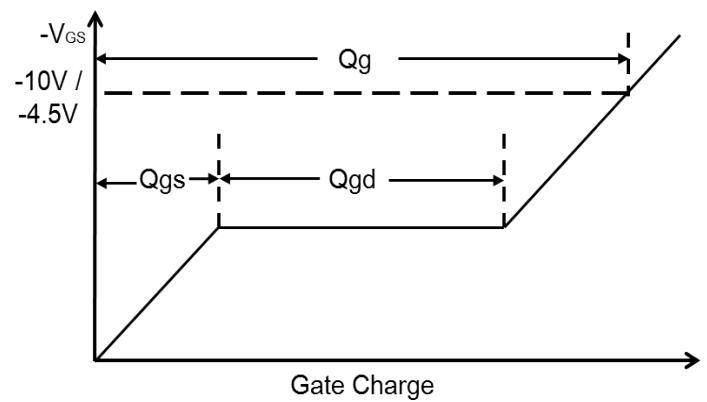
Symbol	Parameter	Condition	Min	Typ	Max	Unit
STATIC PARAMETERS						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=-250\mu A$	-12			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=-12V, V_{GS}=0V$			1	μA
I_{GSS}	Gate-Body Leakage Current	$V_{GS}=\pm 8V, V_{DS}=0V$			± 100	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=-250\mu A$	-0.4	-0.6	-1.0	V
$R_{DS(ON)}$	Drain-Source On-State Resistance	$V_{GS}=-4.5V, I_D=-5A$		22	30	$m\Omega$
		$V_{GS}=-2.5V, I_D=-4A$		30	45	$m\Omega$
DYNAMIC PARAMETERS						
C_{iss}	Input Capacitance	$V_{DS}=-6V, V_{GS}=0V, F=1.0MHz$		1275		pF
C_{oss}	Output Capacitance			255		pF
C_{rss}	Reverse Transfer Capacitance			236		pF
SWITCHING PARAMETERS						
$t_{d(on)}$	Turn-on Delay Time	$V_{DD}=-6V, I_D=-4A, V_{GS}=-4.5V, R_G=6\Omega$		26		nS
t_r	Turn-on Rise Time			24		nS
$t_{d(off)}$	Turn-Off Delay Time			45		nS
t_f	Turn-Off Fall Time			20		nS
Q_g	Total Gate Charge	$V_{DS}=-6V, I_D=-5A, V_{GS}=-4.5V$		14		nC
Q_{gs}	Gate-Source Charge			2.3		nC
Q_{gd}	Gate-Drain Charge			3.6		nC
V_{SD}	Diode Forward Voltage	$V_{GS}=0V, I_{SD}=-1A$		0.72	1.4	V
R_g	Gate resistance	$V_{GS}=0V, V_{DS}=0V, F=1MHz$		4		Ω

Note:

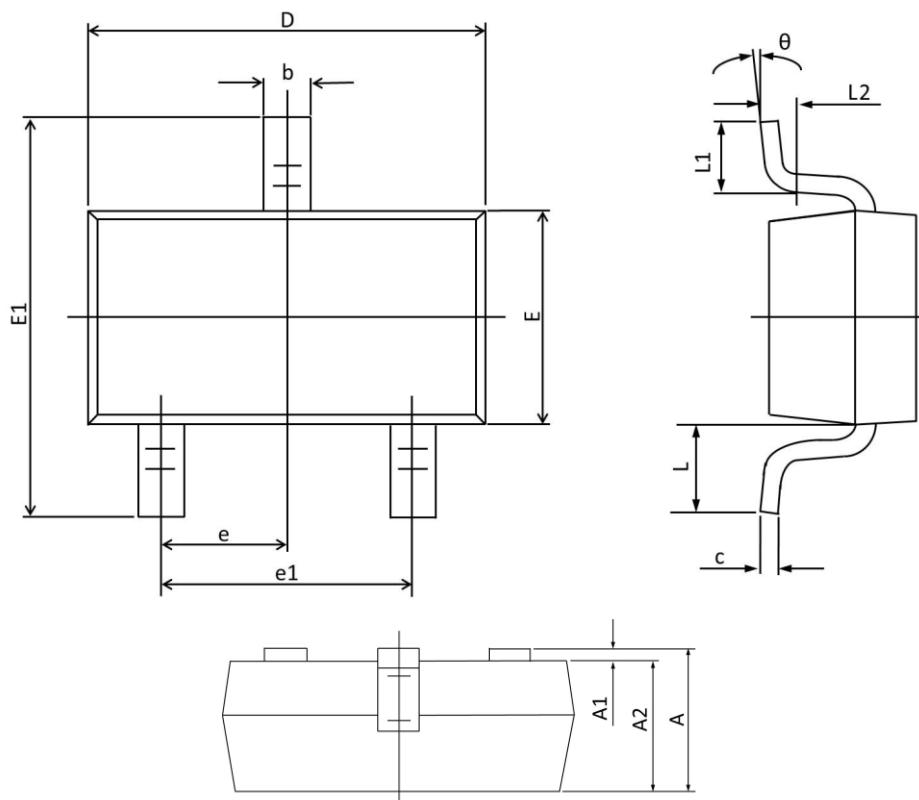
1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. The data tested by pulsed , pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.
3. Essentially independent of operating temperature.

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

**Fig.1 Continuous Drain Current vs. T_c** **Fig.2 Normalized RDS(ON) vs. T_j** **Fig.3 Normalized V_{th} vs. T_j** **Fig.4 Gate Charge Waveform****Fig.5 Normalized Transient Impedance****Fig.6 Maximum Safe Operation Area**

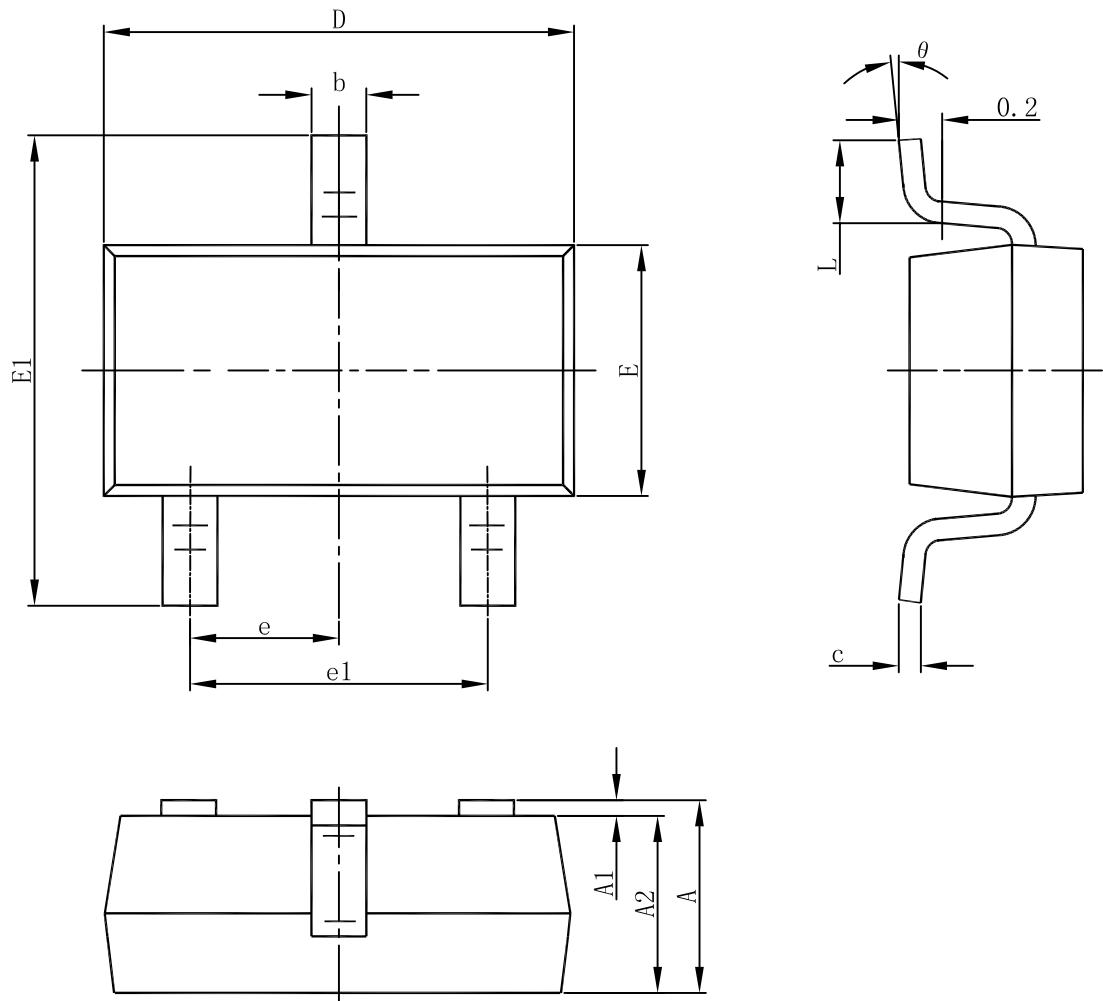
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS**Fig.7** Switching Time Waveform**Fig.8** Gate Charge Waveform

SOT23 PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Max	Min	Max	Min
A	1.150	0.900	0.045	0.035
A1	0.100	0.000	0.004	0.000
A2	1.050	0.900	0.041	0.035
b	0.500	0.300	0.020	0.012
c	0.150	0.080	0.006	0.003
D	3.000	2.800	0.118	0.110
E	1.400	1.200	0.055	0.047
E1	2.550	2.250	0.100	0.089
e	0.95 TYP.		0.037 TYP.	
e1	2.000	1.800	0.079	0.071
L	0.55 REF.		0.022 REF.	
L1	0.500	0.300	0.020	0.012
L2	0.25 TYP.		0.01 TYP.	
theta	8°	0°	8°	0°

SOT23-3 PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950(BSC)		0.037(BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
theta	0°	8°	0°	8°